# RENESAS

## RJK0301DPB

Silicon N Channel Power MOS FET **Power Switching** 

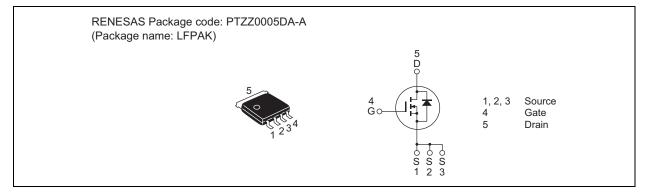
> REJ03G1338-0900 Rev.9.00 Apr 19, 2006

### **Features**

- High speed switching
- Capable of 4.5V gate drive
- Low drive current
- High density mounting
- Low on-resistance

 $R_{DS(on)} = 2.3 \text{ m}\Omega \text{ typ.}$  (at  $V_{GS} = 10 \text{ V}$ )

### Outline



### **Absolute Maximum Ratings**

			$(Ta = 25^{\circ}C)$	
Item	Symbol	Ratings	Unit	
Drain to source voltage	V <sub>DSS</sub>	30	V	
Gate to source voltage	V <sub>GSS</sub>	+16/ -12	V	
Drain current	Ι <sub>D</sub>	60	А	
Drain peak current	Note1	240	А	
Body-drain diode reverse drain current	I <sub>DR</sub>	60	A	
Avalanche current	I <sub>AP</sub> Note 2	30	A	
Avalanche energy	E <sub>AR</sub> Note 2	90	mJ	
Channel dissipation	Pch Note3	65	W	
Channel to Case Thermal Resistance	θch-C	1.93	°C/W	
Channel temperature	Tch	150	°C	
Storage temperature	Tstg	-55 to +150	°C	

Notes: 1.  $PW \le 10 \ \mu s$ , duty cycle  $\le 1\%$ 

2. Value at Tch =  $25^{\circ}$ C, Rg  $\geq 50 \Omega$ 

3. Tc = 25°C



### **Electrical Characteristics**

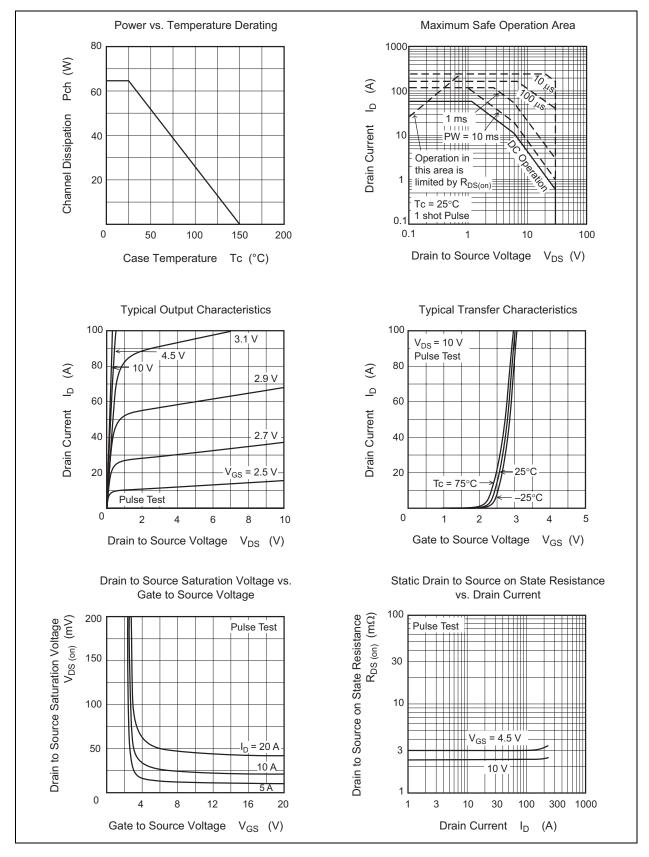
### $(Ta = 25^{\circ}C)$ Symbol Min Unit **Test Conditions** Item Тур Max Drain to source breakdown voltage 30 V $I_{D} = 10 \text{ mA}, V_{GS} = 0$ V<sub>(BR)DSS</sub> \_\_\_\_ $V_{GS} = +16/-12 \text{ V}, \text{ V}_{DS} = 0$ Gate to source leak current ±0.1 μΑ $I_{GSS}$ — — Zero gate voltage drain current μΑ $V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0$ IDSS \_\_\_\_ \_\_\_\_ 1 Gate to source cutoff voltage V<sub>GS(off)</sub> V $V_{DS} = 10 \text{ V}, I_{D} = 1 \text{ mA}$ 1.2 2.5 $I_D = 30 \text{ A}, V_{GS} = 10 \text{ V}^{\text{Note4}}$ Static drain to source on state 2.3 2.8 mΩ $R_{\text{DS}(on)}$ \_\_\_\_ $I_D = 30 \text{ A}, V_{GS} = 4.5 \text{ V}^{Note4}$ resistance 3.0 4.0 R<sub>DS(on)</sub> \_\_\_\_ mΩ $I_D = 30 \text{ A}, V_{DS} = 10 \text{ V}^{Note4}$ Forward transfer admittance y<sub>fs</sub> 110 S pF $V_{DS} = 10 V, V_{GS} = 0,$ Input capacitance Ciss \_\_\_\_ 5000 \_ Coss 1450 f = 1 MHzOutput capacitance \_\_\_\_ \_ pF Reverse transfer capacitance Crss 220 \_\_\_\_ \_ pF Gate Resistance Rg \_ 0.8 \_\_\_ Ω 32 $V_{DD} = 10 \text{ V}, \text{ V}_{GS} = 4.5 \text{ V},$ Total gate charge Qg nC $I_{D} = 50 \text{ A}$ Gate to source charge Qgs \_ 14.5 \_ nC Gate to drain charge \_\_\_\_\_ 7.0 \_\_\_\_ nC Qgd $V_{GS} = 10 \text{ V}, \text{ I}_{D} = 30 \text{ A},$ Turn-on delay time 11.5 ns t<sub>d(on)</sub> \_\_\_\_ \_ $V_{DD} \cong 10 \text{ V}, \text{R}_{\text{L}} = 0.33 \Omega,$ Rise time tr 4.5 ns $Rg = 4.7 \Omega$ Turn-off delay time t<sub>d(off)</sub> 58 ns Fall time tf \_\_\_\_ 6.0 \_ ns $IF = 60 A, V_{GS} = 0^{Note4}$ Body-drain diode forward voltage 0.84 V $V_{\text{DF}}$ 1.10 $IF = 60 A, V_{GS} = 0$ Body-drain diode reverse recovery 50 ns t<sub>rr</sub> \_\_\_\_ \_ di<sub>F</sub>/ dt = 100 A/ μs time

Notes: 4. Pulse test

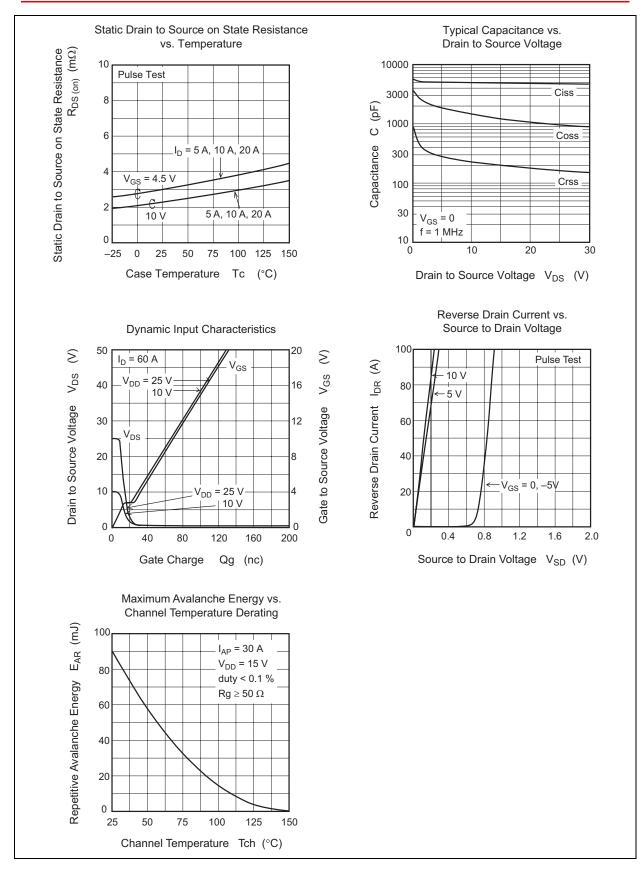
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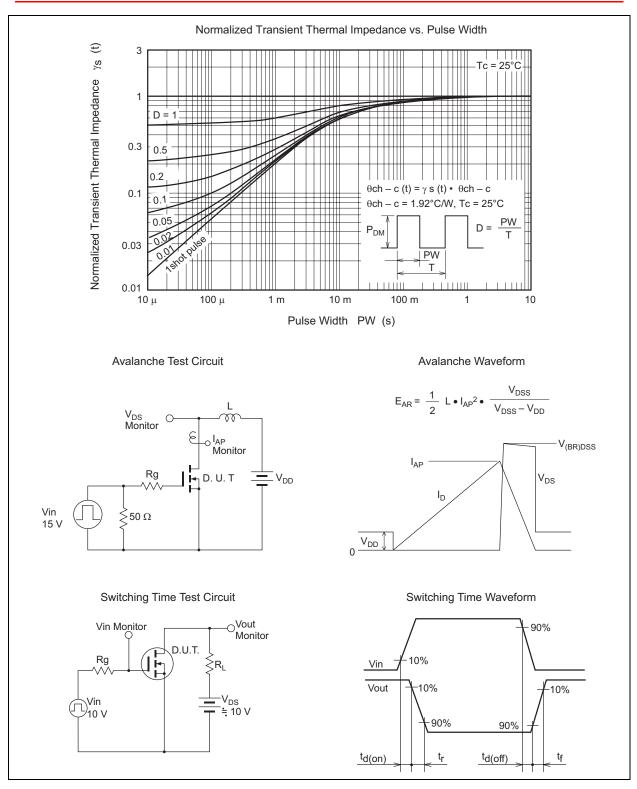
### **Main Characteristics**





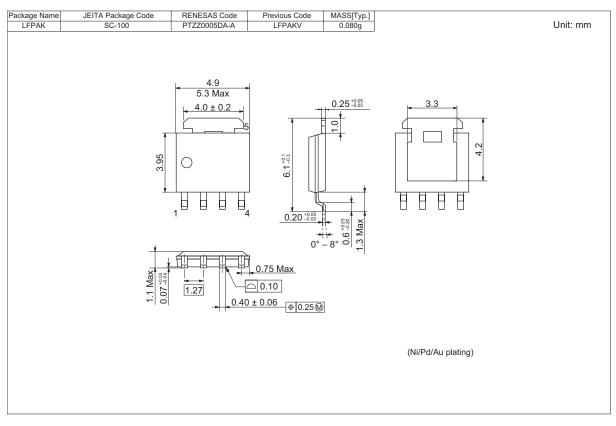








### **Package Dimensions**



### **Ordering Information**

Part Name	Quantity	Shipping Container
RJK0301DPB-00-J0	2500 pcs	Taping

Note: For some grades, production may be terminated. Please contact the Renesas sales office to check the state of production before ordering the product.



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